
MAIN FEATURES

Symbol	value	unit
I _{T(RMS)}	6	A
V _{DRM/V_{RRM}}	600 and 800	V
I _{TSM}	25	A

GENERAL DESCRIPTION

. Glass passivated triacs in a plastic envelope , intended for use in applications requiring high bidirectional transient andblocking voltage capability and high thermal cycling performance.

.Typical applications include motor control, industrial and domestic lighting , heating and static switching.

ABSOLUTE MAXIMUM RATINGS

symbol	parameter	value	unit
I _{T(RMS)}	RMS on-state current (full sine wave)	D ² PAK/TO-220	T _C =107°C
I _{TSM}	Non repetitive surge peak on-state current (full sine wave, T _j =25°C)	t=20ms	25
		t=16.7ms	27
I _{GM}	Peak gate current	2	A
P _{G(AV)}	Average gate power dissipation	T _j =125°C	0.5
T _{stg}	Storage junction temperature range	-40 to +150	
T _j	Operating junction temperature range	-40 to +125	°C

ELECTRICAL CHARACTERISTICS (T_{amb}=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	MIN	MAX	UNIT
Rated repetitive peak off-state voltage	V _{DRM} , V _{RRM}	I _D =10µA	600		V
Rated repetitive peak off-state current	I _{DRM} , I _{RRM}	V _D =520V		10	µA
On-state voltage	V _{TM}	I _T =5A		1.7	V
Gate trigger current	I _{GT}	T ₂ (+), G(+)	V _D =12V R _L =100Ω	10	mA
		T ₂ (+), G(-)		10	mA
		T ₂ (-), G(-)		10	mA
		T ₂ (-), G(+)		-	mA
Gate trigger voltage	V _{GT}	T ₂ (+), G(+)	V _D =12V R _L =100Ω	1.45	V
		T ₂ (+), G(-)		1.45	V
		T ₂ (-), G(-)		1.45	V
		T ₂ (-), G(+)		-	V
Holding current	I _H	I _T =100mA I _G =20mA		20	mA

Typical characteristics

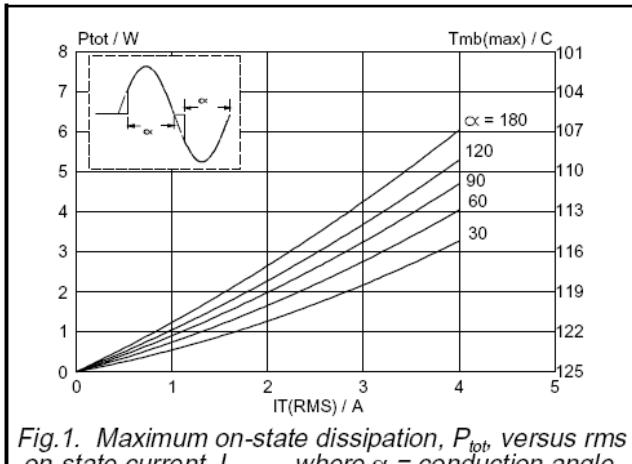


Fig.1. Maximum on-state dissipation, P_{tot} , versus rms on-state current, $I_{T(RMS)}$, where α = conduction angle.

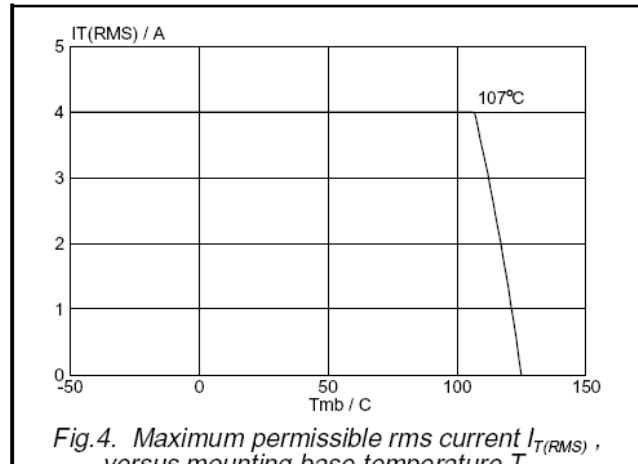


Fig.4. Maximum permissible rms current $I_{T(RMS)}$, versus mounting base temperature T_{mb} .

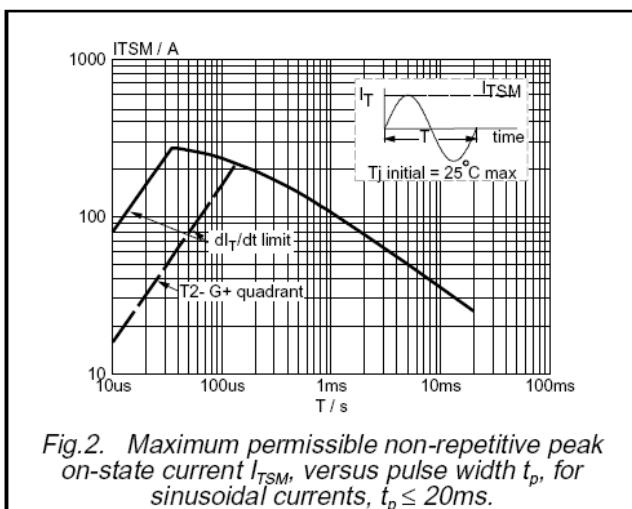


Fig.2. Maximum permissible non-repetitive peak on-state current $I_{TS(M)}$, versus pulse width t_p , for sinusoidal currents, $t_p \leq 20\text{ms}$.

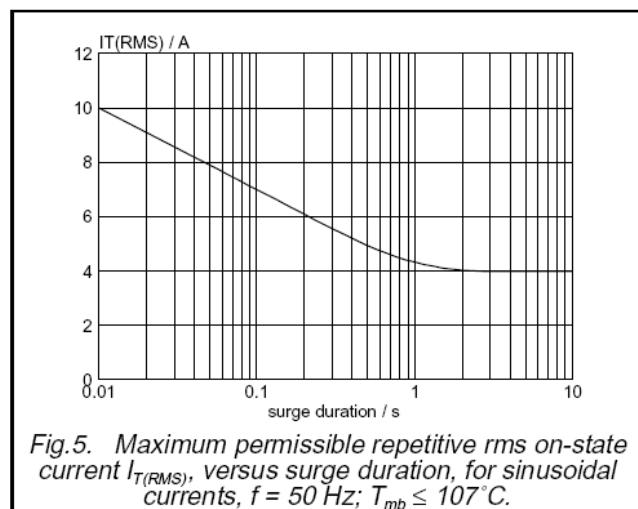


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, $f = 50\text{Hz}$; $T_{mb} \leq 107^\circ\text{C}$.

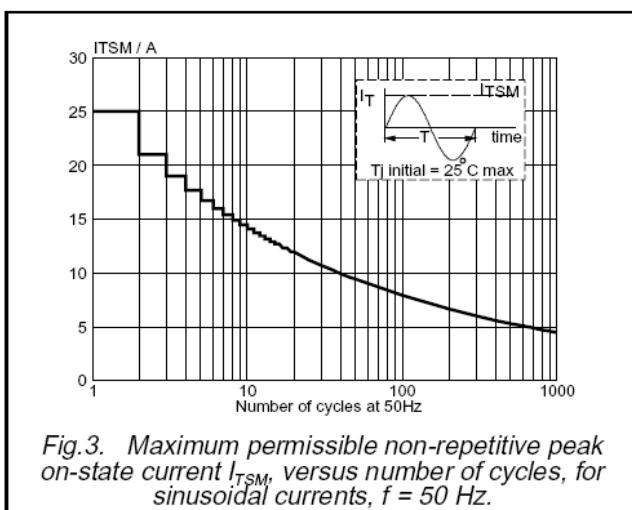


Fig.3. Maximum permissible non-repetitive peak on-state current $I_{TS(M)}$, versus number of cycles, for sinusoidal currents, $f = 50\text{Hz}$.

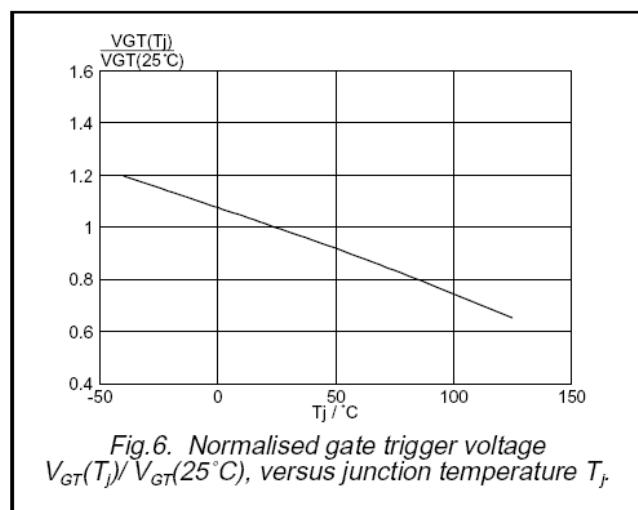


Fig.6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25^\circ\text{C})$, versus junction temperature T_j .

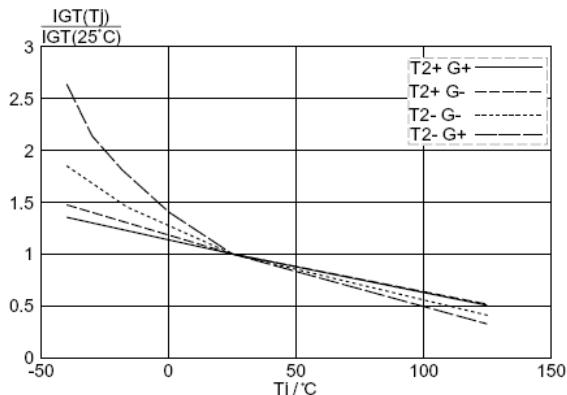


Fig. 7. Normalised gate trigger current $I_{GT}(T_j)/I_{GT}(25^\circ C)$, versus junction temperature T_j .

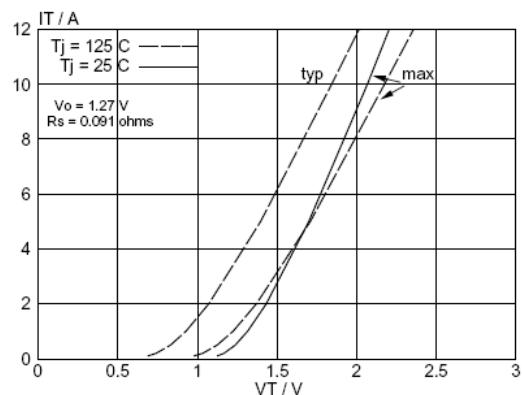


Fig. 10. Typical and maximum on-state characteristic.

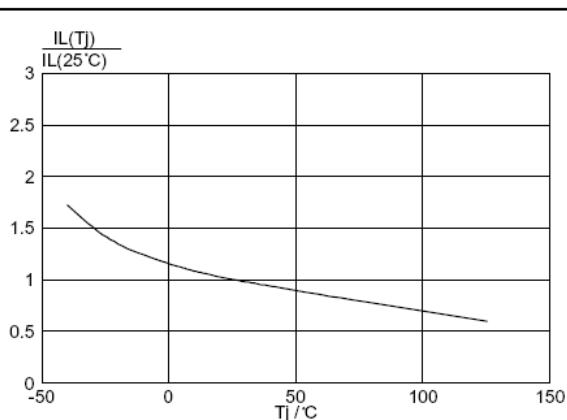


Fig. 8. Normalised latching current $I_L(T_j)/I_L(25^\circ C)$, versus junction temperature T_j .

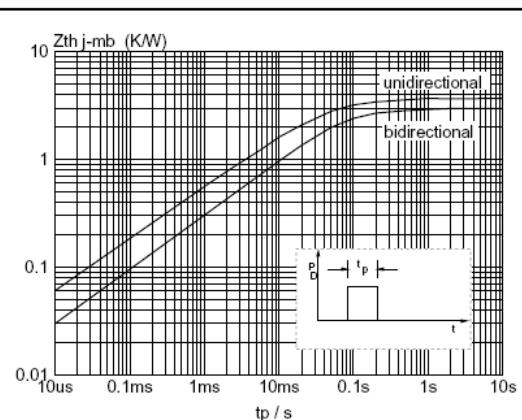


Fig. 11. Transient thermal impedance $Z_{th,j-mb}$, versus pulse width t_p .

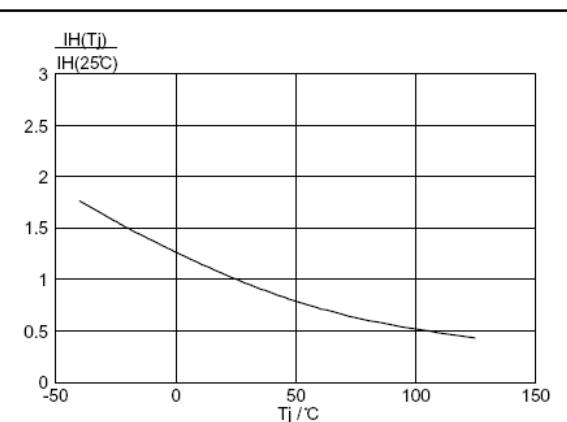


Fig. 9. Normalised holding current $I_H(T_j)/I_H(25^\circ C)$, versus junction temperature T_j .

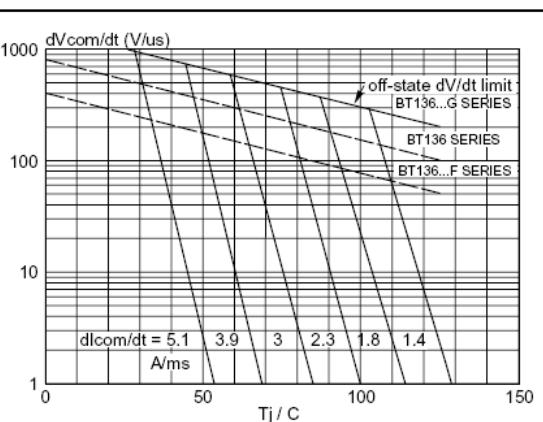


Fig. 12. Typical commutation dV/dt versus junction temperature, parameter commutation dl_T/dt . The triac should commutate when the dV/dt is below the value on the appropriate curve for pre-commutation dl_T/dt .